

### **AMENDMENTS TO THE SPECIFICATION**

Please replace the term “a raised pattern” with the terms “at least one protruding body” and “a pattern”. Detailed amendments are marked as shown in the attached paper, and a clean version is also attached.

Please replace the last paragraph on page 18 with the following amended paragraph:

In this embodiment, first stamp is taken for example. When first stamp is a plate stamp as shown in Fig. 2B, a first plate stamp 390 ~~having a first raised pattern, a first inkpad 395 containing a first ink 400 and~~ [[ , ]]a substrate 405A and a first inkpad 395 having at least one first protruding body are provided. The end surface of each first protruding body constitutes to a first pattern that would be exhibited by the first inkpad 395 in one stamp. Next, a first ink adherence process 315 ~~is performed by first inkpad 395 to ink first raised pattern to form a first pattern on the first predetermined region of~~ on the first plate stamp 390, wherein first ink adherence process 315 comprises a first ink coating process 315A, a first positioning process 315B and a first pattern transferring process 315C. The first ink coating process 315A is performed to coat the first ink 400 uniformly on the first ~~raised pattern protruding body~~ on the first inkpad 395. Next, the first positioning process 315B is performed to move the first plate stamp 390 to a specific place precisely relative to the first predetermined region of the first inkpad 395. Then, the first pattern transferring process 315C is performed to ink the first predetermined region of the first plate stamp 390 by the first inkpad 395 and transfer the first ~~raised pattern~~ pattern on the surface of the first plate stamp 390. After the first ink adherence process 315, a second positioning process 320 is performed to move the inked first plate stamp 390 to a specific place precisely relative to the first predetermined region of the substrate

405A. Next, a second pattern transferring process 325 is performed to ink the first predetermined region of the substrate 405A by the first stamp 390, so as to transfer the first ~~raised~~ pattern on the surface of the substrate 405A. Afterwards, a first fixation process 330 is performed to solidify the first ink 400 on the surface of the substrate 405A, so as to form a substrate 405B with a solidified first ink.

Please replace the last paragraph on page 19 with the following amended paragraph:

In this embodiment, first stamp is again taken for example. When first stamp is a roller stamp as shown in Fig. 2C, a first roller stamp 410 ~~having a first raised pattern~~, a first ~~inkpad 420 containing a first ink 415 and~~ [[ , ]] a substrate 425A and a first inkpad 420 having at least one first protruding body are provided. The end surface of each first protruding body constitutes to a first pattern that would be exhibited by the first inkpad 420 in one stamp. Next, a first ink adherence process 315 is performed ~~by first inkpad 420 to ink first raised pattern to form a first pattern on the first predetermined region of the first roller stamp 410~~, wherein first ink adherence process 315 comprises a first ink coating process 315A, a first positioning process 315B and a first pattern transferring process 315C. The first ink coating process 315A is performed to coat the first ink 415 uniformly on the ~~first raised pattern protruding body~~ on the first inkpad 420. Next, the first positioning process 315B is performed to move the first roller stamp 410 to a specific place precisely relative to the first predetermined region of the first inkpad 420. Then, the first pattern transferring process 315C is performed to ink the first predetermined region of the first roller stamp 410 by the first inkpad 420 and transfer the ~~first raised~~ pattern on the surface of the first roller stamp 410. After the first ink adherence process 315, a second positioning process 320 is performed to move the inked first roller stamp 410 to a specific place precisely relative to the first predetermined region of the

substrate 425A. Next, a second pattern transferring process 325 is performed to ink the first predetermined region of the substrate 425A by the first stamp 410, so as to transfer the first ~~raised~~ pattern on the surface of the substrate 425A. Then, a first fixation process 330 is performed to solidify the first ink 415 on the surface of the substrate 425A, so as to form a substrate 425B with a solidified first ink. Moreover, Fig. 2D is a combination of Fig. 2A with Fig. 2C and shows the complete flow chart of operating roller stamp relative to the inkpad having a ~~raised pattern~~ at least one protruding body.